Acoustic Chip Technology
Shengxin

DATASHEET

of SAW Devices

SAW Filter

Part Number: SXF0625RBNSS04

Center Frequency: 625MHz

Package: SMD3838-6Pin

- Package Dimensions
- Testing Environment
- Electrical Characteristics
- Frequency Characteristics
- Remark and Packing
- Description

Revision Record

Revision Number	Date	Description
SXF0625RBNSS04_RevA/0	2023-03-24	Preliminary Version
SXF0625RBNSS04_RevA/1	2023-04-08	Revision0.2
SXF0625RBNSS04_RevA/2	2023-10-24	Formal Specification (Frequency Characteristics)

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1.Features

■ Low-loss RF filter

■ Low amplitude ripple

■ No matching network required for operation at 50Ω

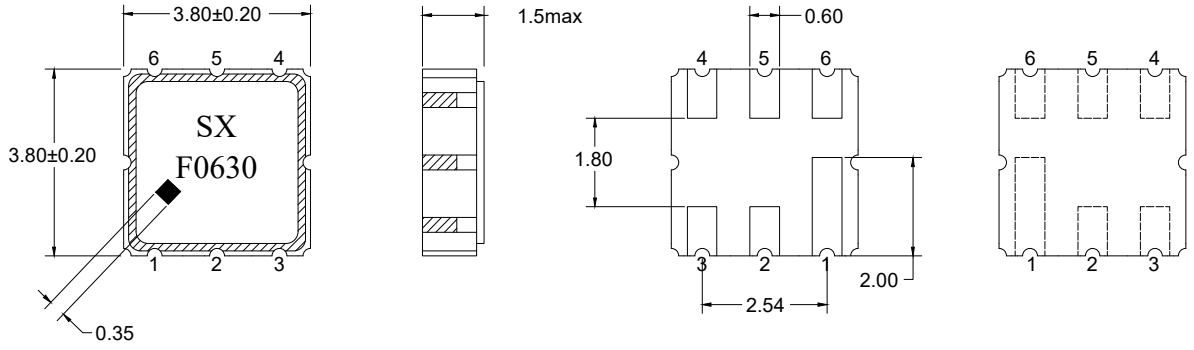
■ Ceramic package for Surface Mounted Technology (SMT)

■ Lead-free production and RoHS Compliant

■ **E**lectrostatic **S**ensitive **D**evice(ESD)

■ **M**oisture **S**ensitivity **L**evel 2

2.Package Dimension (Unit: mm)



Pin Configuration	
2	Input
5	Output
1, 3, 4, 6	To Be Ground

Attention: The mark SXF0630 is for reference.

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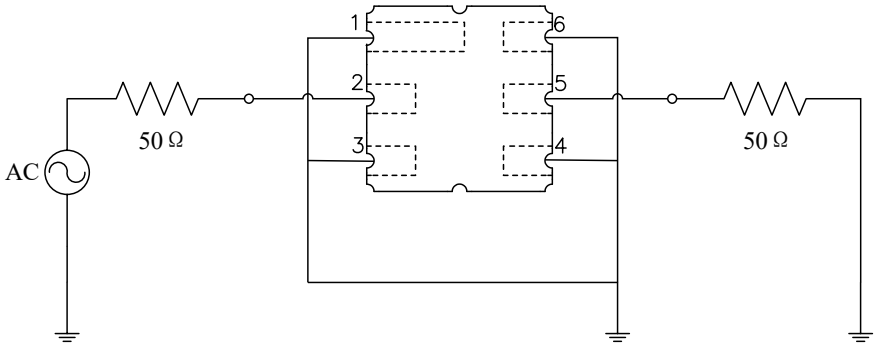
3.Measurement Circuit



4.Maximum Ratings

Rating		Value	Unit
RF Input Power	P	15	dBm
DC Voltage	V_{DC}	5	V
Operating Temperature Range	T_A	-40 ~ +85	°C
Storage Temperature Range	T_{stg}	-45 ~ +85	°C
ESD Voltage(MM)	V_{MM}	50	V
ESD Voltage(HBM)	V_{HBM}	175	V

5.Electrical Specification

Item	Frequency Range [MHz]	Characteristics			
		min.	typ.[1]	max.	Unit
Center Frequency	-	-	625	-	MHz
Insertion Loss	610 - 640	-	3.5	4.5	dB
Amplitude Ripple	610 - 640	-	1.3	2.5	dB
Absolute Attenuation	0.3 - 540	40	59	-	dB
	540 - 570	28	34	-	dB
	700 - 1000	40	52	-	dB
Input/Output Impedance	-	-	50	-	Ohms

1. Typical value at 25±2deg.C

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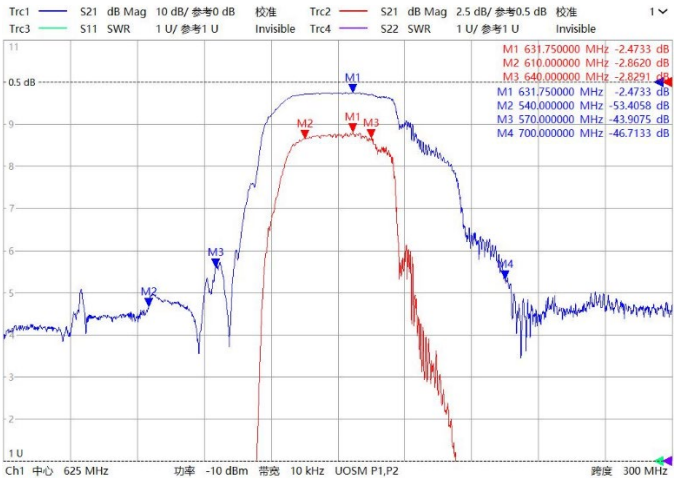
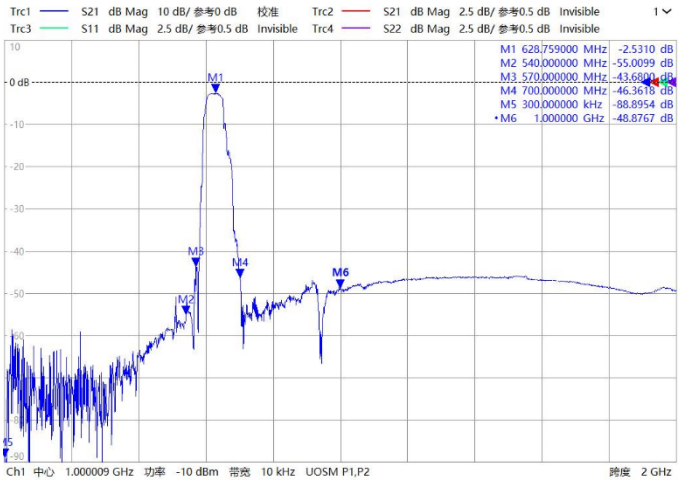
6.Frequency Characteristics

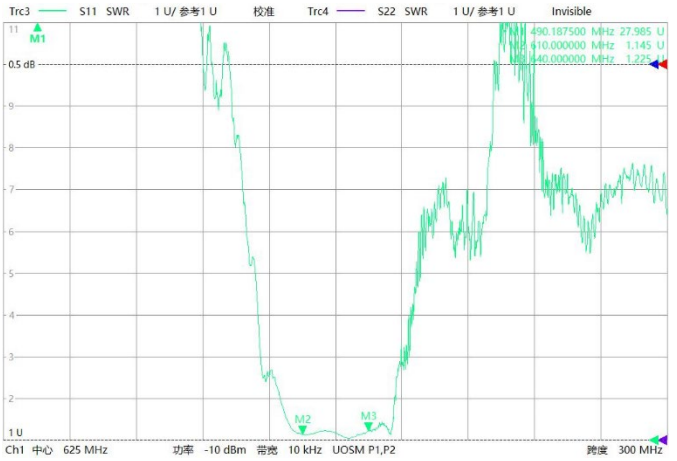
Frequency Response



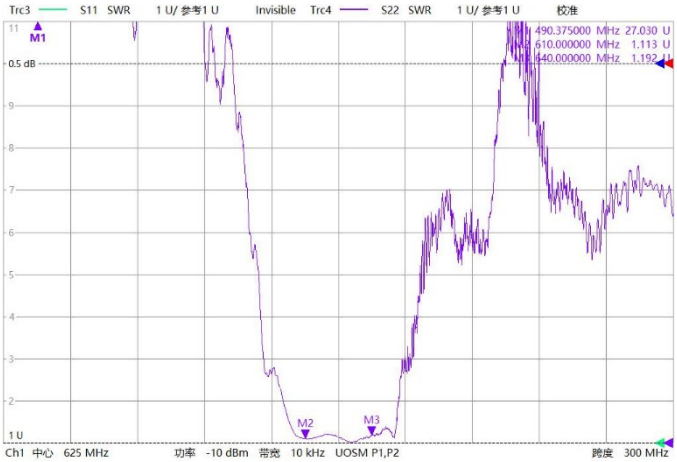
Frequency Response（wideband）



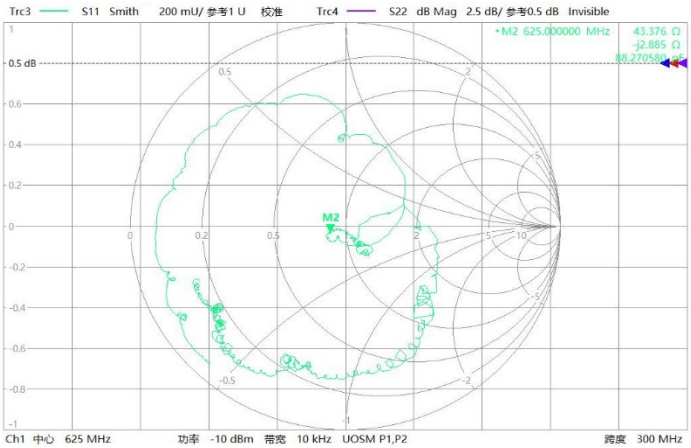
S11 VSWR



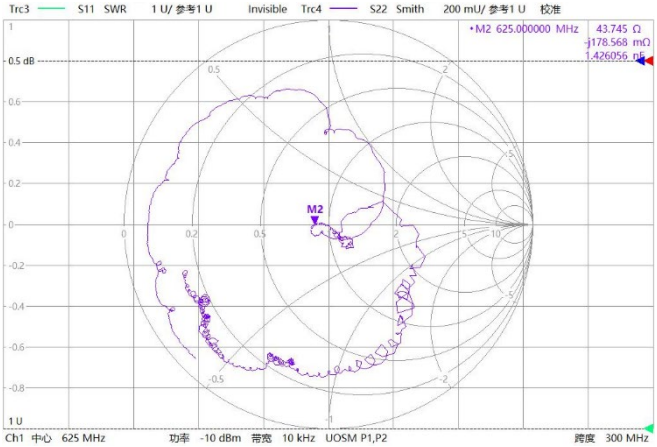
S22 VSWR



S11 Smith Chart



S22 Smith Chart



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7.Reliability Characteristics

No.	Item	Condition to be satisfied
1	High Temp. Storage	①Test temperature: +85℃±3℃ ②Duration time：500 hours ③Restore time: 2 hours at the room temperature(25℃)
2	Low Temp. Storage	①Test temperature: -40℃±3℃ ②Duration Time: 500 hours ③Restore time: 2 hours at the room temperature(25℃)
3	High Temp. High Humidity Storage	①Test temperature: +85℃±3℃ ②Test Humidity：85%±3% ③Duration Hours：240 hours ④Restore time: 2 hours at the room temperature(25℃)
4	Temperature Cycling	①Test Temperature: -40^{0}_{-10}℃~$+85^{+10}_{0}$℃ ②Time for each step: ≥30min ③Conversion time: ≤1min ④Cycle times: 100 times ⑤Restore time: 24 hours at the room temperature(25℃)
5	Soldering heat resistance	①Reflow with 260+0/-5℃, 10±1s (Solder Pot) ②Restore time: 2 hours at the room temperature(25℃)
6	Solderability test	Soldering method and temperature: lead-free reflow soldering, 245±5 ℃ for 5±0.5s

8.Remarks

1. Please be certain not to apply voltage above the rated voltage of SAW components.
2. Please be sure that the component operate within the specified operating temperature range.
3. Abrupt temperature change shall be avoided because deterioration of the component characteristics can occur under that situation.
4. Please be careful of soldering temperature when soldering.
5. Please do not place soldering iron on the body of components.
6. Please be careful not to subject the terminals or leads of components to excessive force.

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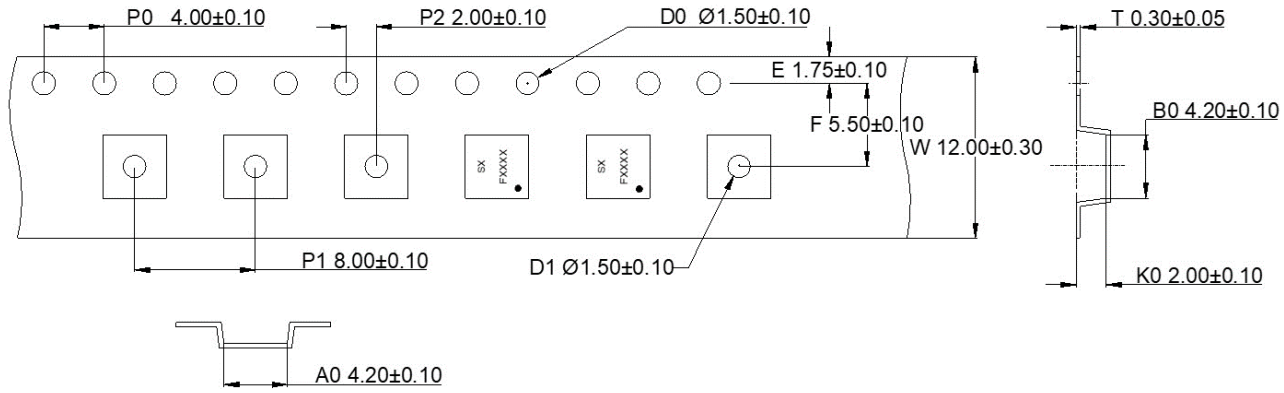
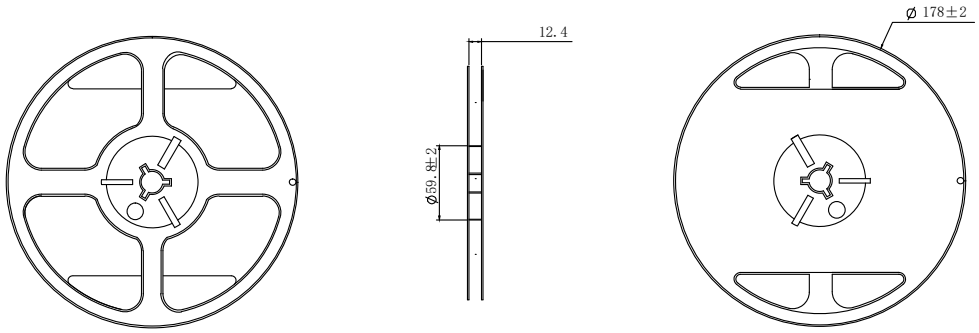
9.Packing Information

Tape(Unit: mm)

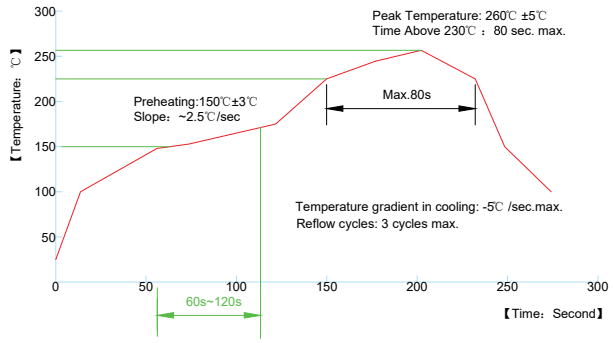


Size	P0	P1	P2	D0	D1	E	F	W	A0	B0	K0	T
Value	4.00	8.00	2.00	Φ1.50	Φ1.50	1.75	5.50	12.00	4.20	4.20	2.00	0.30
Tolerance	±0.10	±0.10	±0.10	±0.10	±0.10	±0.10	±0.10	±0.30	±0.10	±0.10	±0.10	±0.05

Reel： 1000pcs/Reel(Standard Size)



10.Recommended Soldering Profile



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